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(54)	INTEGRAL HOT MELT ADHESIVE
, ,	PACKAGING FILMS AND USE THEREOF

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(58) Field of Classification Search

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(57) ABSTRACT

Propylene polymer based packaging films for encapsulating hot melt adhesives are disclosed. The packaging films are readily miscible with the various hot melt adhesive chemistries during the melting stage without deleteriously affecting the adhesive properties, making the packaging film particularly well suited for packaging hot melt adhesives in a pillow, cylinder, pouch, block, cartridge and like forms.

16 Claims, No Drawings

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INTEGRAL HOT MELT ADHESIVE PACKAGING FILMS AND USE THEREOF

FIELD OF THE INVENTION

The present invention relates to packaging films for encapsulating hot melt adhesives. The packaging films are readily miscible with the hot melt adhesive during the adhesive melting stage without deleteriously affecting the adhesive properties, making the packaging film particularly well suited for packaging hot melt adhesives in a pillow, cylinder, pouch, block, cartridge and the like.

BACKGROUND OF THE INVENTION

Hot melt adhesives are solid at room temperature while generally being applied in the molten or liquid state. Typically, these adhesives are provided in the form of blocks and because of their tacky nature, the solid adhesive blocks not only stick to each other or adhere to mechanical handling devices, but also pick up dirt and other contaminants during transport. Additionally, certain applications that require high tack formulations result in blocks that will deform or cold flow unless supported during shipment.

Various methods of packaging hot melt adhesives have 25 been developed to address the above concerns. In one method, non-tacky powders are applied onto the hot melt adhesives, and the contents are bagged in packaging films. In some applications, the packaging films must be removed before melting the hot melt adhesives. In other methods, and as 30 taught in U.S. Pat. No. 5,373,682 and U.S. Pat. No. 7,350,644, the packaging film is a part of the hot melt adhesive, and the packaging film is dissolved with the adhesive during the melting stage. While these films may not deleteriously affect the adhesive properties, for they are in minor quantities (typi-35 cally less than 5 wt % of the total weight), the films may not readily blend into the molten hot melt adhesives during the heating and application stage. The immiscible portion of the packaging film separates from the hot melt adhesive as a distinct and separate layer by floating on the surface of the 40 melt and/or adhering to the walls of the melt tank, and over time, can cause mechanical problems for the adhesive melt tanks. Because there are numerous types of hot melt adhesives based on various chemistries, the packaging films must be selected to ensure good miscibility with the chosen hot 45 melt adhesive.

There continues to be a need in the art for hot melt adhesive packaging films that allows for wider applicability of hot melt adhesives. The current invention fulfills this need.

BRIEF SUMMARY OF THE INVENTION

The invention provides integral packaging films for various hot melt adhesives. Removal of the integral packaging film is not necessary because the integral packaging film is readily 55 miscible with the hot melt adhesive during the adhesive melting stage without negatively affecting the adhesive properties.

Applicants have discovered that a specific combination of packaging film's chemistry, melt viscosity, melt strength, 60 peak melt temperature, offset melt temperature, and storage modulus are critical in forming a chemically compatible, miscible, film in the integral hot melt adhesive package that is suitable for various hot melt adhesive chemistries.

In one embodiment, the integral packaging film comprises 65 a polymer blend, comprising at least 70 wt % of propylene content; and the packaging film has (a) a viscosity range of

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about 200,000 to 3,000,000 cps at 200° C.; (b) a melting peak temperature range of about 90 to 140° C. (c) a Tm offset temperature below 149° C.; and (d) a storage modulus (G') at 100° C. of about 1×10^{6} to 1×10^{8} Pascal.

Another embodiment is directed to an article that is a hot melt adhesive encapsulated by an integral packaging film. The integral packaging film is completely miscible in the hot melt adhesive without any agitation at 149° C. or higher when the packaging film is present up to 2% of the total weight of the article. The hot melt adhesive comprises poly-alpha-ole-fins, rubbers, styrenic block-copolymers, ethylene-vinyl acetates, ethylene-butyl acetates, and/or mixtures thereof. The integral packaging film comprises a polymer blend, comprising at least 70 wt % of propylene content; and the packaging film has (a) a viscosity range of about 200,000 to 3,000,000 cps at 200° C.; (b) a melting peak temperature range of about 90 to 140° C. (c) a Tm offset temperature below 149° C.; and (d) a storage modulus (G') at 100° C. of about 1×10⁶ to 1×10⁸ Pascal.

Yet another embodiment is directed to the method of packaging a hot melt adhesive with the packaging film to form an integral hot melt adhesive package. The process comprises the step of: (1) preparing the integral packaging film as an encapsulating vessel; (2) pumping or pouring the hot melt adhesive in a molten state into the integral packaging film, and the integral packaging film is in direct contact with a heat sink; (3) sealing the integral packaging film; and (4) cooling the sealed package. The integral packaging film comprises a polymer blend comprising (a) from about 70 to about 99 wt % of propylene content and (b) from about 1 to about 30 wt % of butene and/or ethylene content. The integral hot melt adhesive package is a sealed, non-tacky package that resists dirt and other contaminant during transport.

DETAILED DESCRIPTION OF THE INVENTION

The term "olefin hot melt adhesive" is used herein generically to refer to all polyolefin based hot melt adhesives, including but not limiting to hot melt adhesives made from amorphous olefin, polyethylene, polypropylene, polybutene and their copolymers.

The terms "wrapped," "encapsulated" and "packaged" are used interchangeable herein and mean that blocks of hot melt adhesives are encased within a layer of film. The film is a tackless or non-blocking layer and further serves to protect the adhesive from contamination, serves to allow easy shipping and handling.

The term "integral package film" is used herein as package film that surrounds blocks of hot melt adhesive and can be processed (melted and applied onto substrates) without the removal of the film during the heating and application of the adhesive. Similar to packaged films, the integral package film is also non-blocking and protects the adhesives from contaminations.

The integral packaging film comprises a polymer blend. The polymer blend comprises at least two thermoplastic polymers, and the blend has a propylene content of at least about 70 wt %, and up to about 99 wt %, based on the total weight of the polymer blend. Examples of propylene rich copolymers are LMPP 400 and LMPP 600 from Idemitsu Kosan Co., Ltd; Linxar 127, Vistamaxx 6202, Vistamaxx 6102, Vistamaxx 3980, Vistamaxx 3020, Vistamaxx 3000 from ExxonMobile Corp; and the like.

In one embodiment, the other thermoplastic polymer(s) is a butene and/or ethylene comonomers. The other thermoplastic polymers may account from about 1 wt % to about 30 wt %, based on the total weight of the polymer blend. Ethylenes

may be accountable up to 15 wt %, preferably below 10 wt %, based on the total weight of the polymer blend. Suitable commercial butene rich polymers include Vestoplast 308, Vestoplast 408, Vestoplast 508, Vestoplast 520, Vestoplast 608, Vestoplast 703 from Evonik Industries, and the like.

Suitable commercial ethylene rich polymers include Affinity GA1950 from Dow Chemicals, and the like.

At least one thermoplastic polymer is a metallocene catalyzed polymer. Suitable polymers include metallocene catalyzed polyethylenes, ethylene-butene and ethylene-octane elastomers, plastomers, propylene-butene, propylene-ethylene copolymers.

The films may, if desired, contain antioxidants for enhanced stability as well as other optional components including slip agents such as erucamide, anti-blocking agents such as diatomaceous earth, fatty amides or other processing aids, anti-stats, stabilizers, plasticizers, dyes, perfumes, fillers such as talc or calcium carbonate and the like.

The polymer blends may be blended by any means known 20 in the art. In one embodiment, the polymer blend is processed in a twin screw extruder for mixing and melting. The melted blend is then cast to a film by any means known in the art. The thickness of the film will generally vary from about 0.5 mil to about 5 mil, preferably from about 1 mil to about 3 mil. The 25 thickness of the particular film also varies depending upon the composition and application temperature. The film may be a monolayer or multi-layered film.

It has been discovered that the packaging film must have a specific combination of properties in order to form an integral 30 hot melt adhesive package that is chemically compatible with various hot melt adhesive chemistries while maintaining integrity as a packaging film for the hot melt adhesives. Such packaging film requires (a) a viscosity range of about 200,000 to 3,000,000 cps at 200° C.; (b) a peak melting temperature (Tm) range of about 90 to 140° C. (c) a melting temperature (Tm) offset temperature below 149° C.; and (d) a storage modulus (G') range of about 1×10⁶ to about 1×10⁸ Pascal at 100° C.

The peak melting points and offset can be determined by various methods known in the art. The reported peak melting points and Tm offset values reported herein were determined with a DSC (differential scanning calorimetry). Unless otherwise stated, about 5 mg of the film sample was sealed in a crimped alumina pan, cooled the sample to -40° C., and reheated it to 180° C. at a rate of 10° C./min with 2920 DSC TA Instruments. The endothermic melting peak on the second heat up cycle was used to evaluate the peak melting point and heat of fusion, and the end of melting peak was the Tm offset temperature.

The packaging film must encompass all of the above properties in order to form a packaging film, maintain integrity of the film while encapsulating a molten adhesive, result in a non-tacky barrier seal for the molten adhesive and dissolve completely in with the hot melt adhesive upon melting without any agitation. The packaging film is non-blocking at elevated temperatures, temperatures that simulate box car conditions (35-45° C.). The packaging film melts at temperatures above about 149° C. without any agitation or additional energy within 5 hours. The packaging film is meltable together with various and multiple hot melt adhesives and is blendable into the molten hot melt adhesives without deleteriously affecting the properties of the adhesive.

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EXAMENTATION TO THE PACKAGING THE

Another embodiment is directed to an article comprising a hot melt adhesive encased with a packing film. The article is an integral hot melt adhesive package formed as a pillow, cylinder, pouch, block, cartridge or chub.

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The hot melt adhesive of the integral hot melt adhesive package comprises various thermoplastic polymers. The hot melt adhesives are mainly composed of polymers that include poly-alpha-olefins, rubbers, styrenic block-copolymers, ethylene-vinyl acetates, ethylene-butyl acetates, and/or mixtures thereof. The hot melt adhesives may optionally comprise tackifiers, plasticizer, oils, waxes, and additives.

In one embodiment, the packaging film comprise up to about 2% by weight of the integral hot melt adhesive package, and preferably from about 0.1 to about 1.5%, in order to prevent undue dilution of the adhesive properties. Typically, each packing film has a thickness range of from about 0.5 mil to about 5 mil, preferably from about 1 mil to about 3 mil.

The packaging film of the integral hot melt adhesive package is miscible in various hot melt adhesives without any portions of the film separating from the molten hot melt adhesive by floating on the surface of the hot melt or adhering to the walls of the melt tank.

Typically to form a miscible, chemically compatible and non-separating adhesive, the packaging film is chosen based on the predominant polymer used in the hot melt adhesive. Failure to pick a compatible hot melt adhesive and packaging film results in portions of the films floating on the surface of the hot melt or adhering to the walls of the melt tank. It has been discovered that the instant packaging film is miscible with multiple hot melt adhesive chemistries, e.g., polyolefins, rubbers, ethylene-vinyl acetate copolymers, polyamides, polyesters, polyurethanes, and the like, while forming a nontacky outer protection.

To package a hot melt adhesive with the packaging film, the hot melt adhesive is melted and pumped or poured into a cylindrical thermoplastic film, where the cylindrical tube being in direct contact with a heat sink, e.g., cooled water or a cooled liquid or gaseous environment. Wrapping and sealing the film can occur either manually or, more preferably, by an automated procedure. The hot melt adhesive being poured or pumped is at a temperature at or above the melting point of the packaging film and the interior of the packaging film becomes melted together with the molten hot melt adhesive and blended into the molten adhesive without deleteriously affecting the properties of the adhesive. The molten hot melt adhesive filled cylinder is sealed and allowed to solidify. Optionally, air is removed with a vacuum during the sealing process, and as a result no gap exists between the film and the hot melt adhesive. The resultant individually integral hot melt adhesive packages can be stored, handled and used without the individual packages sticking together, adhering to other objects, or becoming contaminated even if exposed to increased pressure and/or temperature.

To ultimately utilize the integral hot melt adhesive packages as an adhesive, the package is placed to the melt tank, without removing the film. The strong interface or interphase, between the hot melt adhesive and integral packaging film, requires very little additional energy to melt and blend the film into the adhesive itself

EXAMPLES

Example 1

Samples 1-7 were formed as packaging film. The propylene (PP) and butane/ethylene comonomer contents are listed in Table 1. Viscosity was measured at 200° C. with a rheometer with near-zero shear. The films were formed by melting the polymer components through a twin-screw extruder, and then casting it on a cold roll at a thickness of 1.5 mil. The miscibility of the film was evaluated by melting approxi-

mately 10,000 grams of an amorphous poly alpha-olefin adhesive (DISPOMELT® LITE 300 from Henkel Corporation) in a melt tank with about 0.5 wt % (based on the adhesive) of the film sample at 160° C. The length of time that it took for the film sample to melt into the adhesive, without any agitation, was recorded. For Sample 8, EVA film with 3% VA content blow film was also employed for this study.

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gram adjusted the strain at each temperature increment. The shear storage or elastic modulus (G') was calculated by the software from the torque and strain data.

The film strength of the film sample was evaluated by encapsulating a molten DISPOMELT® LITE Lite 300 with the film samples to form a package. The quality and the strength of the package after cooling were visually evaluated.

TABLE 1

		P	olymer blen	i.		
Film Sample	Propylen (%)	Butene/ Ethylene Comonomer (%)	Viscosity (cps at 200° C.)	MFR (ref.) g/10 min @ 230° C.	Film Feasibility	Film Miscibility
1	36.4	63.4	45,000	N/A	Difficult	N/A
2	73.2	26.8	1,000,000	N/A	good	≤3 h
3	91.5	8.5	3,000,000	8.3	good	≤3 h
4	97	3	1,800,000	12	good	≤3 h
5	97	3	680,000	30	good	≤3 h
6	97	3	810,000	N/A	good	≤3 h
7	Non-metallocene-(PP) based polymer (~97% PP and 3% comonomer)		2,200,000	12	good	>5 h
8		ith 3% VA	5,000,000	2.3	good	>24 h

N/A-not available

Film sample 1, with a low melt viscosity, less than 200,000 at 200° C., could not be converted to a film. All other samples, Film Samples 2-8, were cast as films.

Film samples 2-6 were melted into DISPOMELT® LITE 300, and became a homogeneous mass in less than three hours. Film sample 7 also became homogenous mass, but the non-metallocene based polypropylene copolymer film took greater than five hours to become miscible with the amorphous poly-alpha-olefin type hot melt adhesive. EVA film, 35 Film Sample 8, took more than 24 hours to melt into the adhesive. Moreover, the EVA film gelled and formed hard clusters, and some of the hard clusters floated on the hot melt tank surfaces. Such hard clusters are undesirable for they tend to block the spray or slot nozzles.

Example 2

The melting temperature and melt modulus of the sample films were characterized to assess their melt strength, and the 45 results are shown in Table 2. Melting points were determined with a 2920 DSC (differential scanning calorimetry) TA Instruments. About 5-10 mg of a sample was sealed in a crimped alumina pan, cooled to -40° C., and reheated it to 180° C. at a rate of 10° C./min with 2920 DSC TA Instruments. The second heat up cycle was used to evaluate the peak melting point and Tm offset values.

The storage modulus (G') of the film at 100° C. was measured by a Rheometric Dynamic Analyzer (RDA III) and TA Orchestrator software version 7.2.0.2. The adhesive sample is loaded into parallel plates 7.9 mm in diameter and separated by a gap of about 2 mm. The sample was then cooled to about -30° C., and the time program was started. The program test increased the temperature at 5° C. intervals followed by a soak time at each temperature of 10 seconds. The convection oven containing the sample was flushed continuously with nitrogen. The frequency is maintained at 10 rad/s. The initial strain at the start of the test was 0.05% (at the outer edge of the plates). An autostrain option in the software was used to maintain an accurately measurable torque throughout the test. 65 The option was configured such that the maximum applied strain allowed by the software was 30%. The autostrain pro-

If the film sample maintained the integrity and formed an encasement of the hot melt adhesive, the film was given a rating of "strong." If any holes or the hot melt adhesive destroyed the integrity of the film sample, then a rating of "weak" was given to the film.

TABLE 2

	_	Melt S	trength	
	Film Sample	Tm Peak (° C.)	G' at 100° C. (Pascal)	Film strength
0	1	104	1.0×10^{4}	Weak
	2	82	4.5×10^4	Weak
	3	80	7.0×10^4	Weak
	8	106	2.0×10^{6}	Strong
	4	123	6.0×10^6	Strong
	5	138	1.5×10^{7}	Strong
5	6	123	8.0×10^{6}	Strong
	7	147	2.5×10^{8}	Strong
	8	106	2×10^{6}	Strong

Samples 1-3 burst during the filling process, resulting in unacceptable packages. Sample 4-8 was strong enough to form acceptable packages without any bursts in the sample film. It was discovered that peak Tm ranges of about 90 to 140° C. and a storage modulus of about 1×10^{6} to about 1×10^{8} Pascal at 100° C. allowed the films to withstand the filling process and result in acceptable quality of packages.

Example 3

Samples 4-8 were tested for their sprayability. About 10,000 g sample of DISPOMELT LITE® Lite 300 adhesive was encapsulated with a sample film having a thickness of about 1.5 mil. The package was loaded into a hot melt tank set for 160° C. for three hours for samples 4-6 (ten hours for sample 7, and 24 hours for sample 8). The molten adhesive was then sprayed through a four-port ITW spray head (Nordson) and the number of stray globs/minute was recorded in Table 3. The Tm offset of each of the sample film are also recorded in Table 3.

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Film/adhesive package's meltdown and sprayability				
Film Sample	Stray Sprayability (with DISPOMELT ® LITE 300)	Tm offset (° C.)		
4	2 globs/min	134		
5	2 globs/min	144		
6	2 globs/min	144		
7	>10 globs/min	158		
8	>400 globs/min	115		

Sample 7 had greater than 10 stray globs/minute. In contrast, samples 4-6 had only two stray globs/minute. Unlike sample 7, samples 4-6 have Tm offset values lower than 149° C. It was discovered that packaging films having Tm offset value below149° C. is an important factor to minimize strays in sprayability. While Sample 8 also has a Tm Offset value less than 149° C., immiscibility of the EVA film with the encapsulated adhesive is a limitation resulting in increased strays.

Example 4

Hot melt adhesive packages with various hot melt adhesives (1,000 g) and packaging film (0.5 wt % based on the hot melt adhesive) were formed and are listed in Table 4. Each package was loaded into a hot melt tank and heated at the listed temperature without any agitation. The miscibility of the film in the hot melt adhesives was visually observed. Also, the length of time required to fully dissolve the film sample and become miscible in the adhesive was noted.

TABLE 4

Film Miscibility with Various Hot Melt Adhesive				
Hot Melt Adhesive (polymer type)	Film	Testing Temperature	Miscibility Observation	
DISPOMELT ® ® LITE 300 from Henkel Corporation (Amorphous poly-alpha olefin adhesive)	Film sample 5	160° C.	Completely Miscible in less than 3 hours	
DISPOMELT 901B from Henkel Corporation (Styrenic block copolymer based adhesive	Film sample 5	160° C.	Completely Miscible in less than 3 hours	

As observed above, the packaging film(1) made with a polypropylene copolymer that comprises at least 70 wt % propylene content; (2) has a viscosity range of about 200,000 to 3,000,000 cps at 200° C.; (3) has a melting peak temperature range of about 90 to 140° C., (4) has an Tm offset temperature below 149° C;(5) has a storage modulus (G') at 100° C. of about 1×10^{6} to 1×10^{8} Pascal, is miscible with various and multiple hot melt adhesives formed from various polymers, and may be used as a universal packaging adhesive $_{55}$ for integral hot melt adhesive packages.

We claim:

- A hot melt packaging film comprising a polymer blend, wherein the polymer blend comprises at least 70 wt % of propylene content and up to 15 wt % of ethylene content; 60 and
- wherein the packaging film has (a) a viscosity range of about 200,000 to 3,000,000 cps at 200° C.; (b) a peak melting temperature range of about 90 to 140° C. (c) a Tm offset temperature below 149° C.; and (d) a storage 65 modulus (G') range of about 1×10⁶ to about 1×10⁸ Pascal at 100° C.

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- 2. The packaging film of claim 1 further comprising an additive selected from the group consisting of anti-blocking agent, antioxidant, flow modifier, filler, dye and mixtures thereof.
- 3. The packaging film of claim 1 wherein at least one polymer in the polymer blend is a metallocene catalyzed polypropylene polymer.
- **4**. The packaging film of claim **1** wherein the polymer blend comprises ethylene and/or butene comonomers.
- 5. The packaging film of claim 4 wherein the polymer blend comprises:
 - a. from about 70 to about 99 wt % of propylene content;
 - b. from about 1 to about 30 wt % or butene content and;
 - c. less than about about 10 wt % of ethylene content.
 - 6. An article comprising the packaging film of claim 1.
- 7. The article of claim 6, which is a hot melt adhesive package.
- 8. The article of claim 7, which is a pillow, cylinder, pouch, block, cartridge or chub.
 - 9. An integral hot melt adhesive package comprising:
 - (a) a hot melt adhesive selected from the group consisting of poly-alpha-olefins, rubbers, styrenic block-copolymers, ethylene-vinyl acetates, ethylene-butyl acetates, and mixtures thereof; and
 - (b) a packaging film, which comprises a polymer blend comprising at least 70 wt % of propylene and up to 15 wt % of ethylene content; and wherein the packaging film has (a) a viscosity range of about 200,000 to 3,000,000 cps at 200° C.; (b) a peak melting temperature range of about 90 to 140° C. (c) a Tm offset temperature below 149° C.; and (d) a storage modulus (G') range of about 1×10⁶ to about 1×10⁸ Pascal at 100° C.;
 - wherein the packaging film is present in the hot melt adhesive package from about 0.2 to about 2%, based on the total weight of the hot melt adhesive package;
 - wherein the packaging film is 100% miscible in the hot melt adhesive without any agitation at temperatures of 149° C. or greater:
 - wherein the integral hot melt adhesive package comprises the hot melt adhesive encased with the packaging film; and
 - wherein the integral hot melt adhesive package is formed as a pillow, cylinder, pouch, block, cartridge or chub.
 - 10. The integral hot melt adhesive package of claim 9 wherein the packaging film further comprises an additive selected from the group consisting of anti-blocking agent, antioxidant, flow modifier, filler, dye and mixtures thereof.
 - 11. The integral hot melt adhesive package of claim 9 wherein at least one polymer in the polymer blend is a metallocene catalyzed polypropylene polymer.
 - 12. The integral hot melt adhesive package of claim 11 wherein the polymer blend comprises ethylene and/or butene comonomers.
 - 13. The integral hot melt adhesive package of claim 11 wherein the polymer blend comprises:
 - a. from about 70 to about 99 wt % of propylene content;
 - b. from about 1 to about 30 wt % or butene content and;
 - c. less than about about 10 wt % of ethylene content.
 - 14. The integral hot melt adhesive package of claim 9 wherein the hot melt adhesive is a poly-alpha-olefins, olefin block copolymers or styrenic block-copolymer based adhesive.
 - 15. The integral hot melt adhesive package of claim 9 comprising a monolayered packaging film with a thickness of about 0.5 mil to about 5 mil.

16. The integral hot melt adhesive package of claim 9 comprising a multilayered packaging film, wherein each layer has a thickness of about 0.5 mil to about 5 mil.

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* * * * *

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UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATE OF CORRECTION

PATENT NO. : 9,272,795 B2

APPLICATION NO. : 13/800445 DATED : March 1, 2016

INVENTOR(S) : Jinyu Chen, Yuhong Hu and Darshak Desai

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

```
In the Specification
Column 2, Line 2: After "140° C.", insert --; --.
Column 2, Line 60: Change "LMPP 600" to -- LMPPS600 --.
Column 3, Line 36: After "140° C.", insert --; --.
Column 3, Line 65: Change "packing film" to -- packaging film --.
Column 4, Line 12: Change "packing film" to -- packaging film --.
Column 4, Line 51: Change "to" to -- into --.
Column 5, Line 1: After "poly", insert -- ---.
Column 5, Table 1 (column 2): Change "Propylen" to -- Propylene --.
Column 5, Line 29: Change "Samples" to -- samples --.
Column 5, Line 36: Change "Sample" to -- sample --.
Column 6, Line 5: After "DISPOMELT® LITE", delete "Lite".
Column 6, Table 2 (row 4): Delete "Row 4 - Film Sample 8".
Column 6, Line 50: Change "Sample 4-8 was" to -- Samples 4-8 were --.
Column 6, Line 59: Change "DISPOMELT LITE® Lite 300" to -- DISPOMELT® LITE 300 ---
Column 7, Line 17: Change "Sample 8" to -- sample 8 --.
Column 7, Table 4: After "8", delete "8".
Column 7, Table 4: After "alpha", insert -- --.
Column 7, Line 51: After "140° C.", insert --; --.
In the Claims
Column 7, Line 64: After "140° C.", insert --; --.
Column 8, Line 1: After "claim 1", insert --, --.
Column 8, Line 5: After "claim 1", insert --, --.
Column 8, Line 8: After "claim 1", insert -- , --.
Column 8, Line 10: After "claim 4", insert --, --.
Column 8, Line 13: Change "or" to -- of --.
Column 8, Line 32: After "140° C.", insert --; --.
Column 8, Line 46: After "claim 9", insert --, --.
Column 8, Line 50: After "claim 9", insert --, --.
```

Signed and Sealed this Twenty-fifth Day of April, 2017

Michelle K. Lee

Michelle K. Lee

Director of the United States Patent and Trademark Office

CERTIFICATE OF CORRECTION (continued) U.S. Pat. No. 9,272,795 B2

Column 8, Line 53: After "claim 11", insert --, --.

Column 8, Line 56: After "claim 11", insert --, --.

Column 8, Line 59: Change "or" to -- of --.

Column 8, Line 61: After "claim 9", insert --, --.

Column 8, Line 65: After "claim 9", insert --, --.

Column 9, Line 1: After "claim 9", insert --, --.